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# Non-Destructive Characterization of Dense Ceramics

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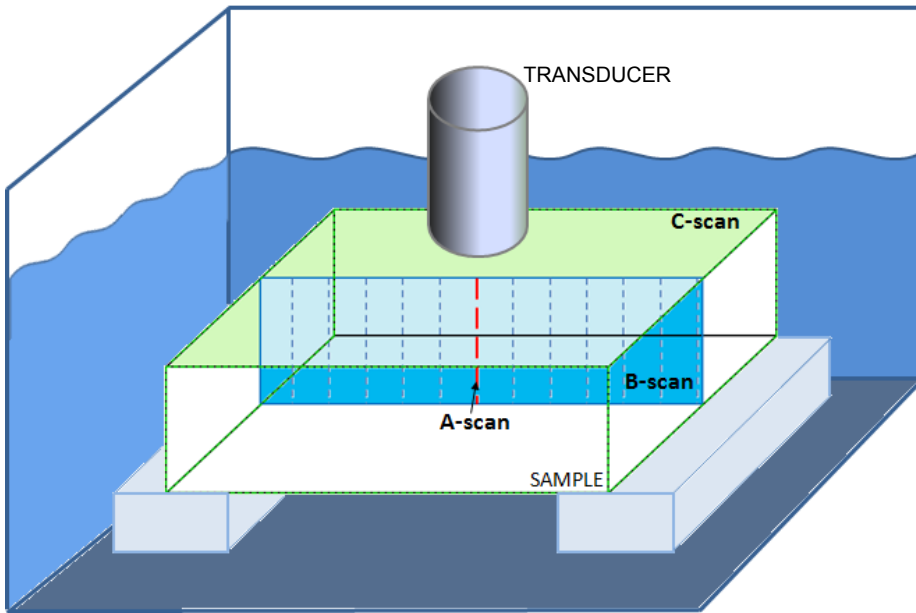
**V. DeLuca**

**R.A. Haber**

**CCOMC Meeting**

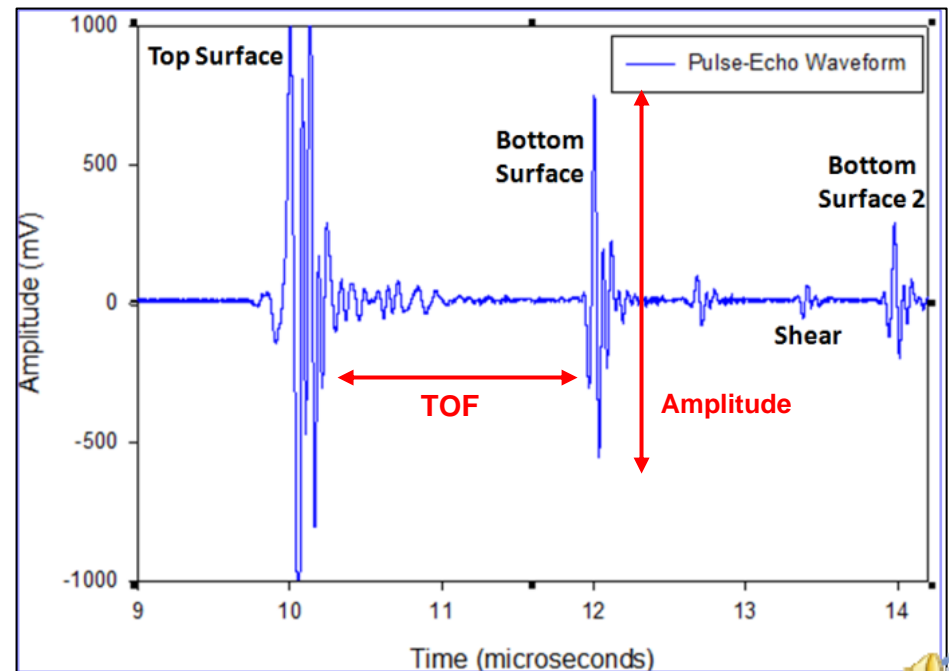
**April 2012**

# Ultrasound NDE Basics



- Immersion-based, pulse-echo system
- A-scans point measurements useful for quickly evaluating properties
- C-scan imaging mode useful for mapping material property variations

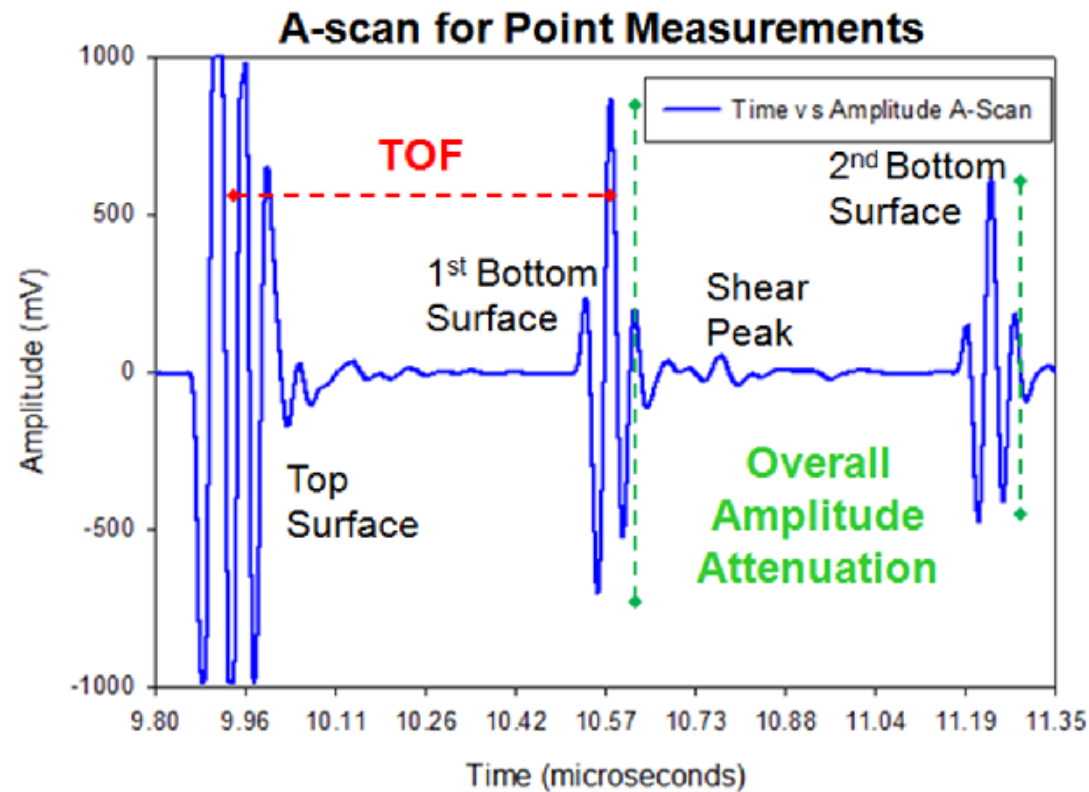
- Analysis of time of flight (TOF) can determine speed of sound in material → elastic properties
- Analysis of amplitude variations can determine acoustic attenuation in material



# A-scan Point Measurements

## Time-of-Flight Based Measurements

- Measures Longitudinal TOF and Shear TOF
- Dependent on density of material
- Can tolerate non-ideal sample surfaces
- Can quickly determine:
  - Longitudinal and shear speeds of sound
  - Poisson ratio
  - Young's modulus
  - Shear modulus
  - Bulk modulus



## Amplitude Based Measurements

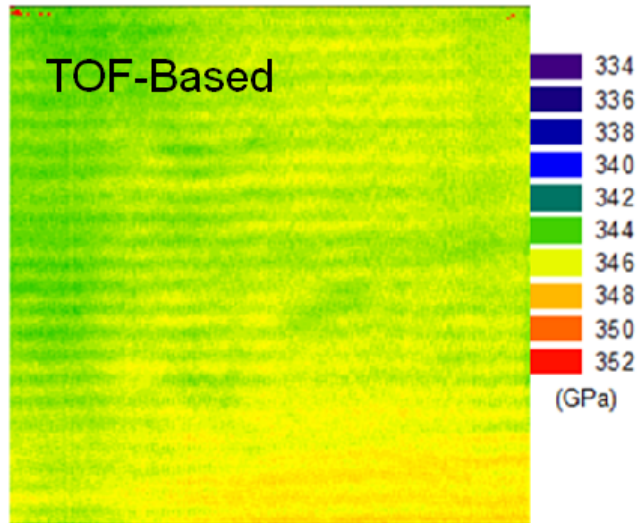
- Measures average drop in intensity over all frequencies
- Useful in determining sample heterogeneities

Information comes from a single point → What if the sample is not uniform?

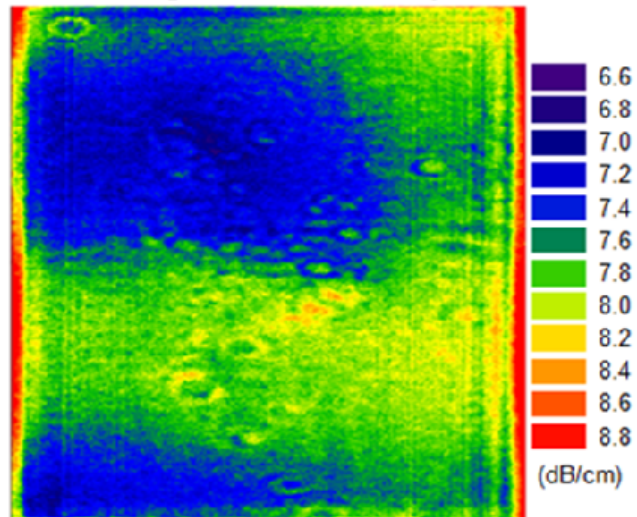


# C-scan Property Mapping

## C-scans for Area Property Maps



Young's Modulus Map



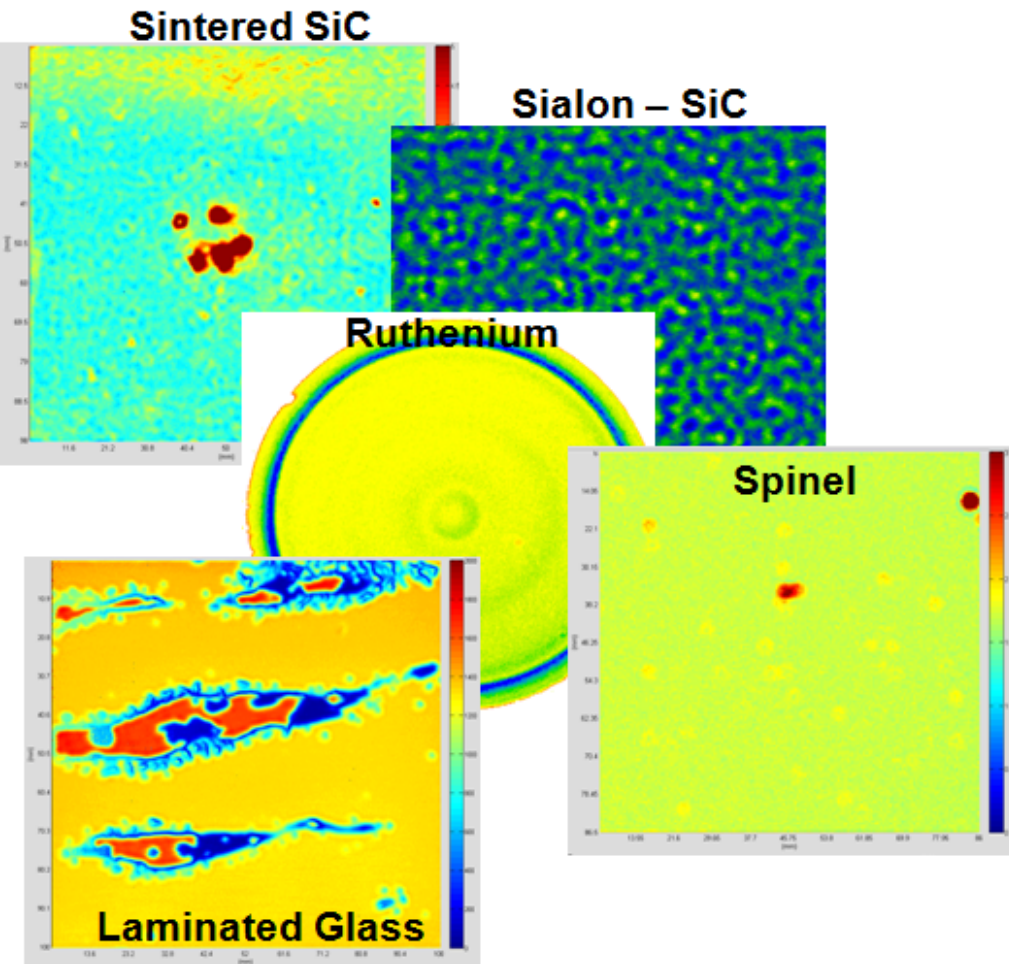
Attenuation Coefficient Map

## C-scan Mapping

- Determining elastic property variations  
→ Semblance of porosity variations
- Spatially locating large, anomalous features
- C-scans → Sensitive to sample nonuniformities
  - Surface scratches 100 $\mu$ m and greater apparent
  - Thickness gradient of 100 $\mu$ m and greater apparent
  - Sample thickness greater than 2"
  - Porosity greater than 10%
- 4" x 4" tile scan in 30 minutes



# Evaluation vs. Characterization



- NDE identifies anomalous defects
  - Composition?
  - Effect on local microstructure?
- NDE measures elastic properties
  - Relate to density
  - New batch compositions introduce elements that reduce density but improve microstructure
- Which values are ‘good’?
- What is the cause of variations?
- ***What about microstructure?***
  - ***Grain size***
  - ***Solid inclusions***
  - ***Secondary phases***

- mapping of velocity and amplitude variations
- Rapid identification of anomalous defects

**Develop Characterization Method To Answer These Questions**



# Characterization-Based Measurements

## Acoustic Attenuation

- Exponential decrease in acoustic energy defined by Beer-Lambert Law
- Very sensitive to wavelength (frequency)
- Attenuation caused by a multitude of loss mechanisms *controlled by microstructure*

### Beer-Lambert Law

Acoustic intensity after propagation

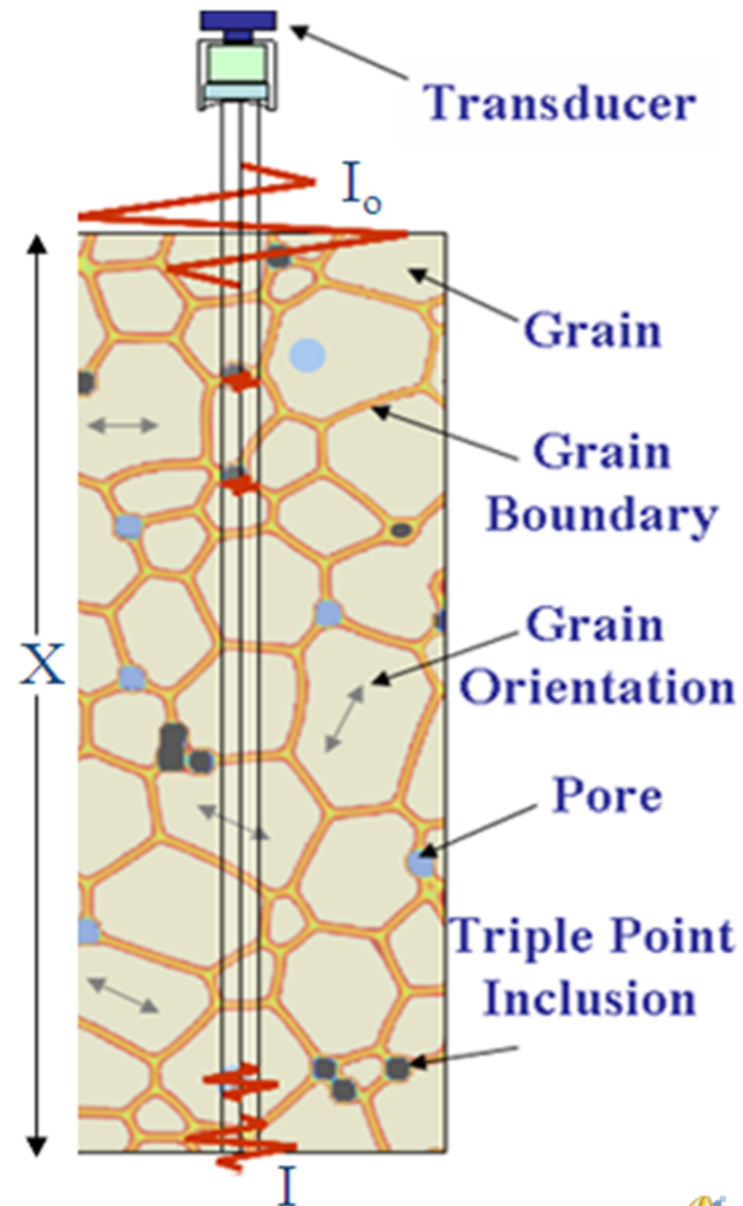
$$I = I_0 e^{-\alpha x}$$

Acoustic intensity before propagation

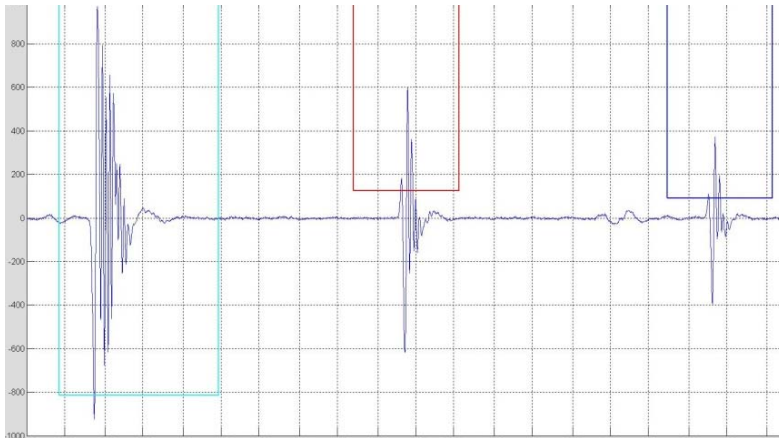
$\alpha$  measured in dB/cm

Attenuation coefficient

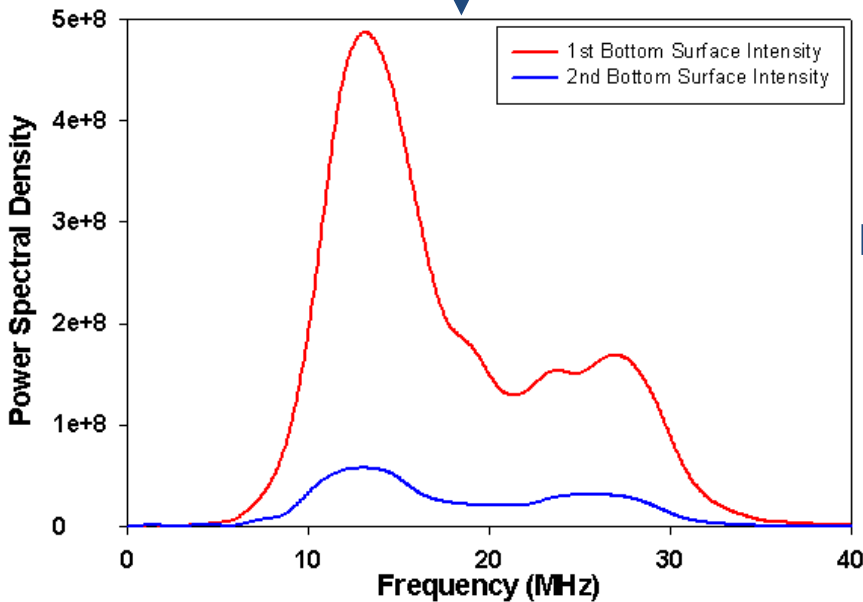
Path length (sample thickness)



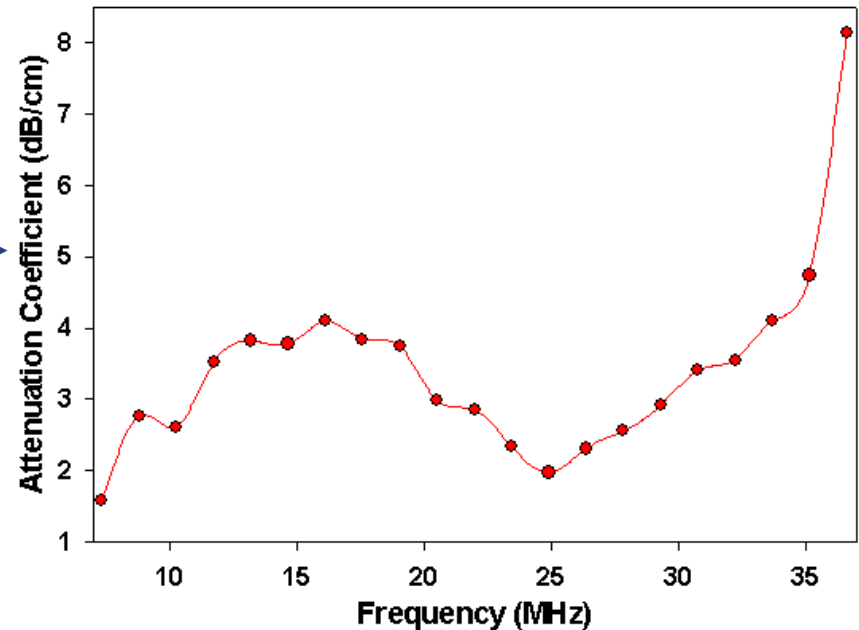
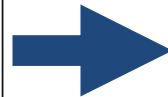
# From NDE to NDC: Acoustic Spectroscopy



A-scan of sample



FFT of bottom surface peaks



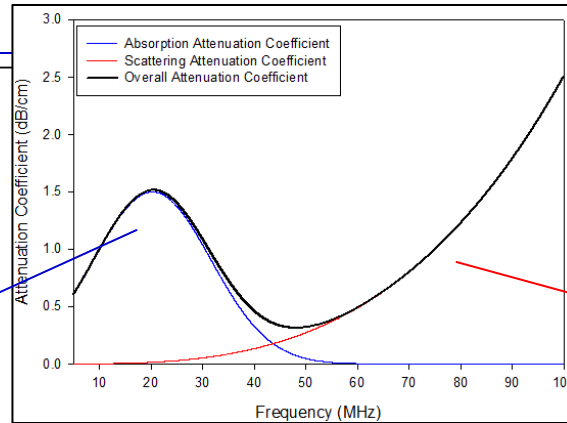
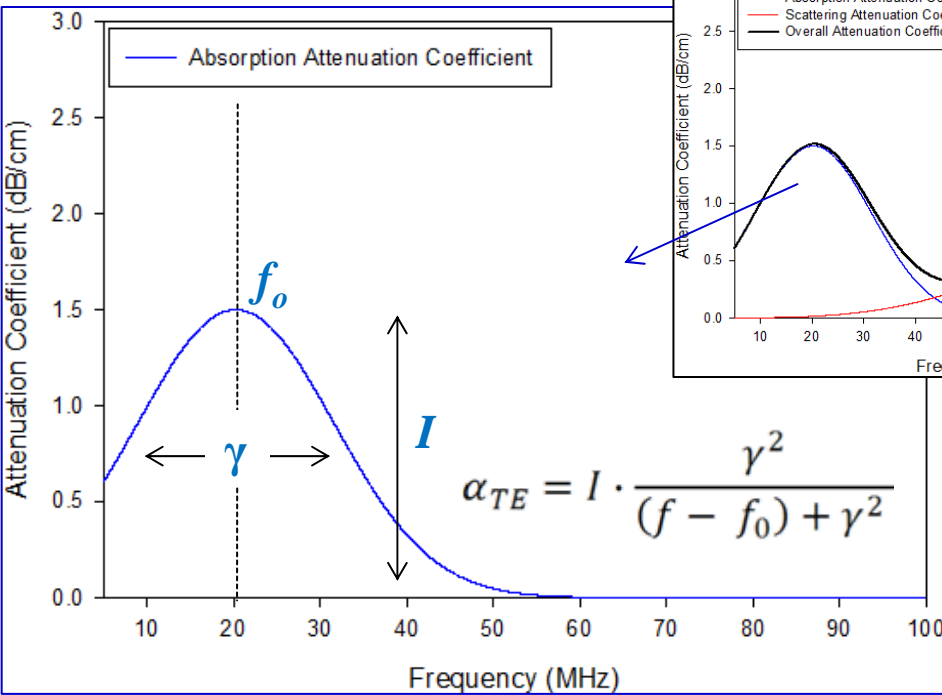
Attenuation Coefficient Spectrum



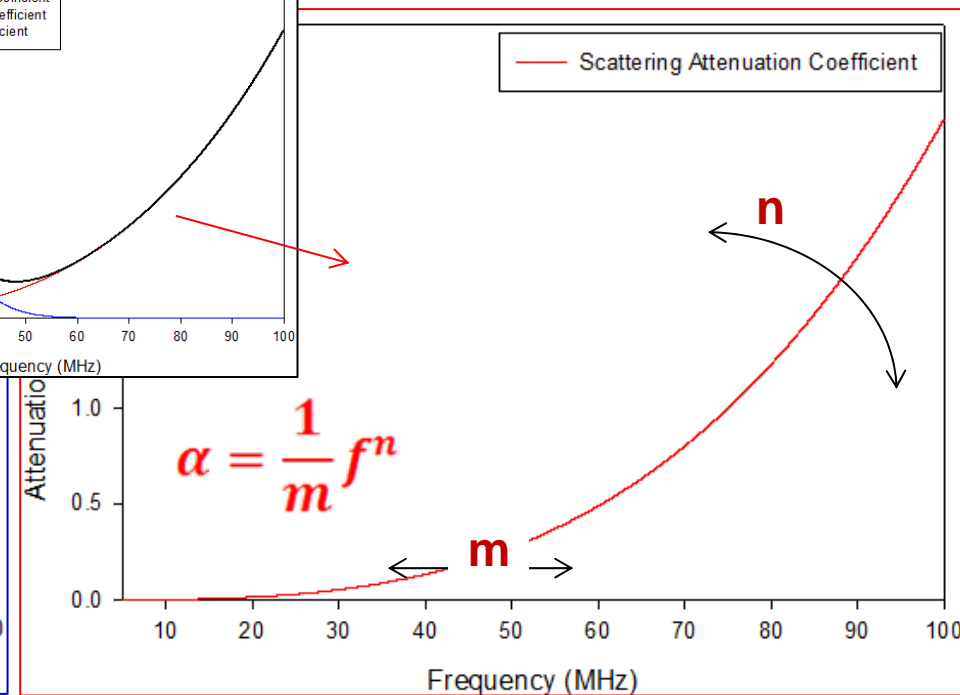
- Measures energy loss at each measured frequency
- Possible to characterize microstructure through knowledge of loss mechanisms within material
- Total attenuation is a summation of **absorption** and **scattering** effects

# Acoustic Spectroscopy

## Absorption Regime



## Scattering Regime



$$f_0 = \frac{\pi X}{2 \rho C_V a^2} \quad \dagger$$

$a$  - diameter  
 $C_V$  - specific heat  
 $X$  - thermal conductivity  
 $\rho$  - density

$$\alpha = C_R a^3 f^4 \quad \text{Rayleigh scattering (} a \ll \lambda \text{)}$$

$$\alpha = C_S a f^2 \quad \text{Stochastic scattering (} a \sim \lambda \text{)}$$

$$\alpha = \frac{C_D f^0}{a} \quad \text{Diffuse scattering (} a > \lambda \text{)}$$

Material	$\rho$ (kg/m <sup>3</sup> )	$X$ (W/mK)	$C_V$ (J/kgK)	$a$ ( $\mu$ m) ( $F_0=10$ MHz)	$a$ ( $\mu$ m) ( $F_0=30$ MHz)
SiC	3210	145.64	667	3.27	1.89
Carbon	2266	131.81	704	3.60	2.08
B <sub>4</sub> C	2510	28	968	1.35	0.78

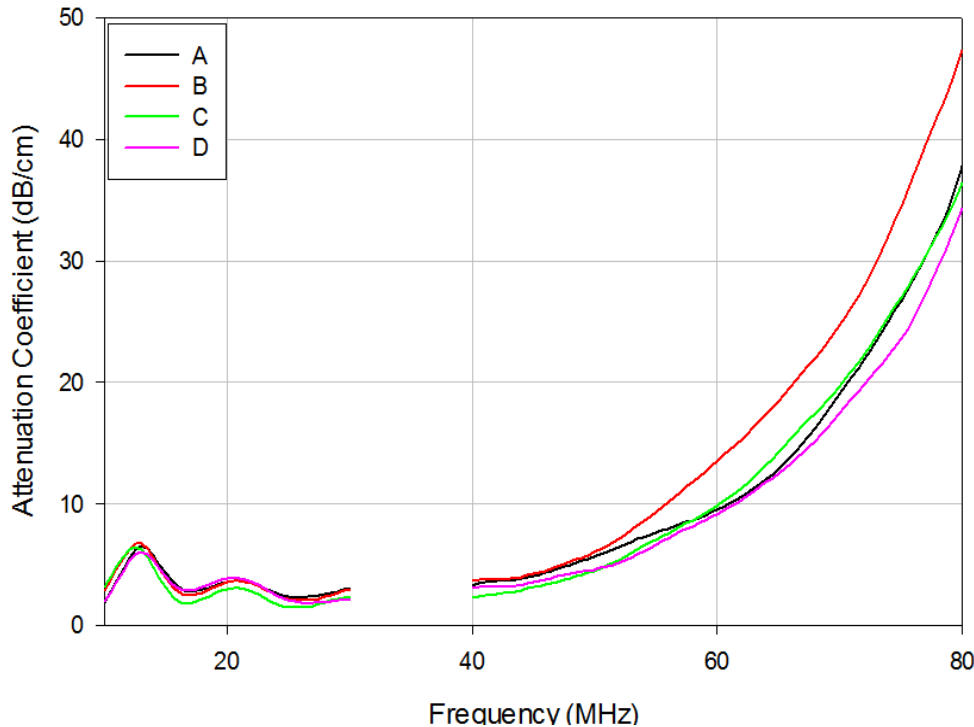
Can we use ultrasound to predict microstructural characteristics?



<sup>†</sup>Zener, C., "Internal Friction in Solids." Proceedings of the Physical Society, vol. 52, pp. 152-167, 1940.

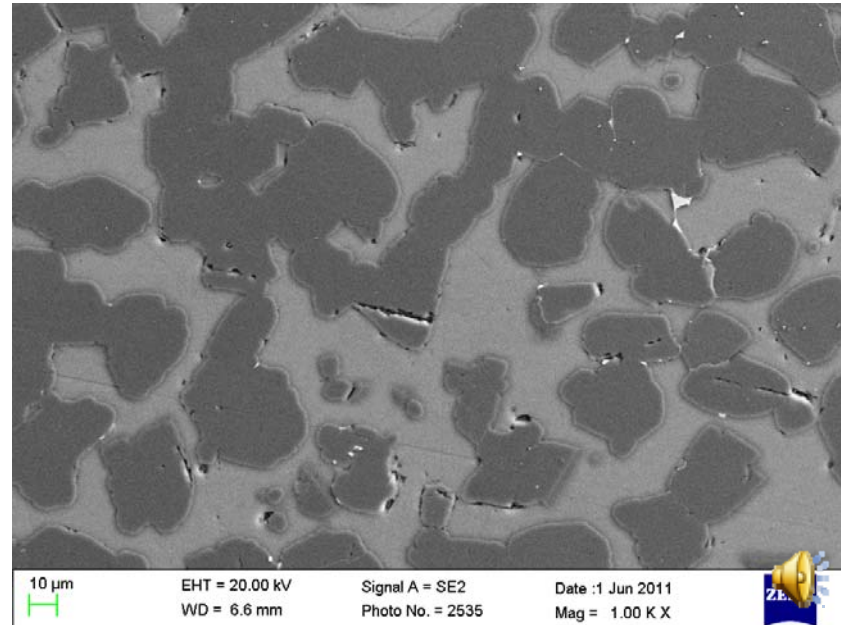


# Acoustic Spectroscopy Example



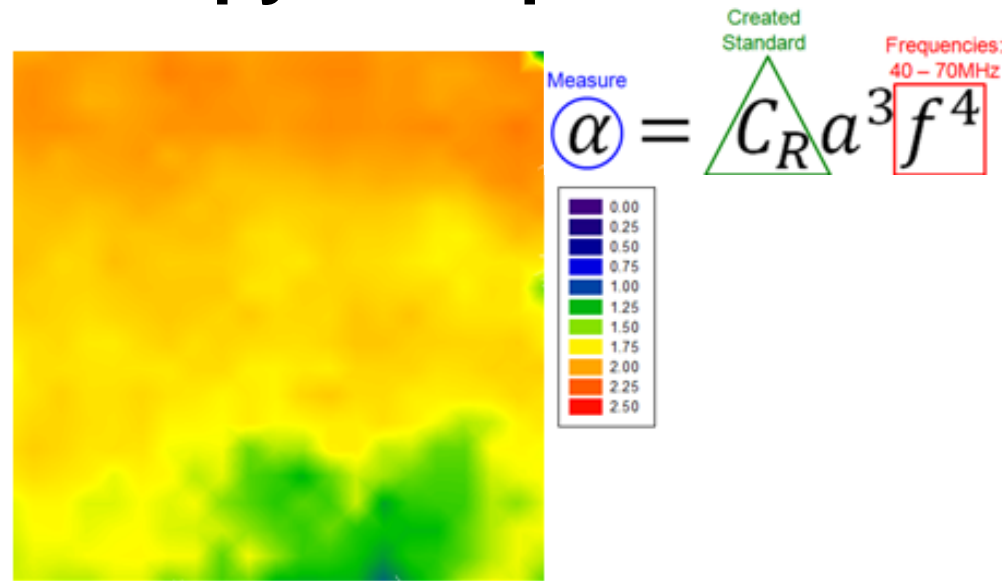
- Reaction bonded SiC samples
- Well defined absorption peaks at lower frequencies
- Smooth transition to power law behavior at higher frequencies
  - Exponent of  $\sim 4$  indicative of predominantly Rayleigh scattering

- Absorption peaks predict secondary phase particles of  $\sim 8-10\mu\text{m}$
- Rayleigh scattering behavior predicts SiC grain size of  $\sim 10-50\mu\text{m}$
- FESEM imaging shows that predictions are reasonable

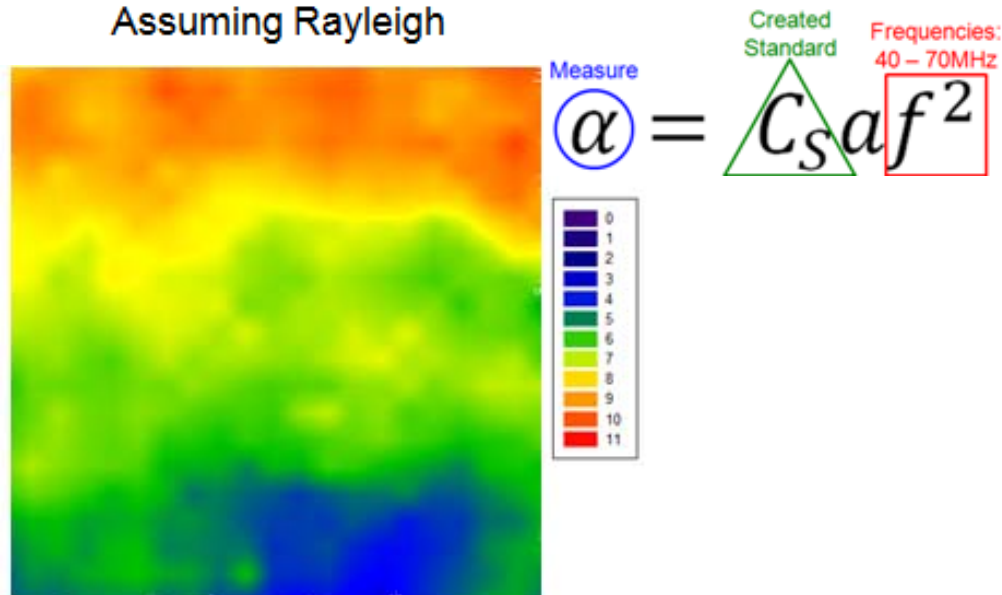


# Acoustic Spectroscopy Example

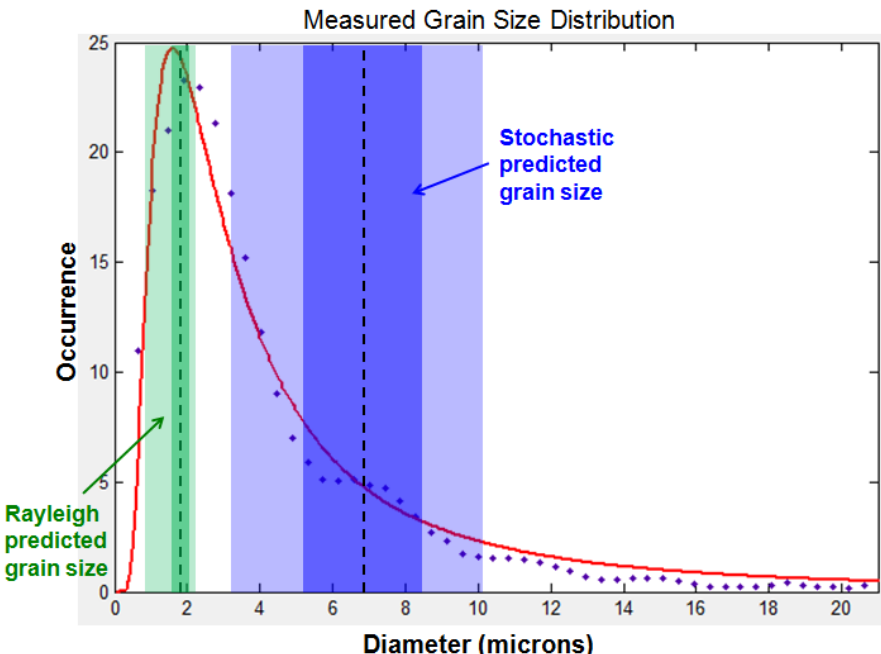
- Extracting microstructural information is not trivial
- Requires knowledge of material
  - Secondary phases
  - Inclusions
  - Concentration
  - Composition
  - Scattering prefactors
- **Need standard reference materials**



Mean Grain Size Map ( $\mu\text{m}$ )  
Assuming Rayleigh



Mean Grain Size Map ( $\mu\text{m}$ )  
Assuming Stochastic

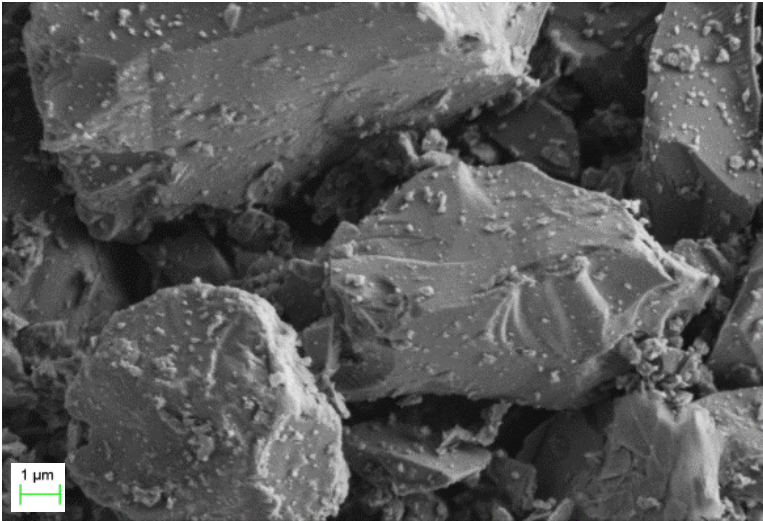


# Goals

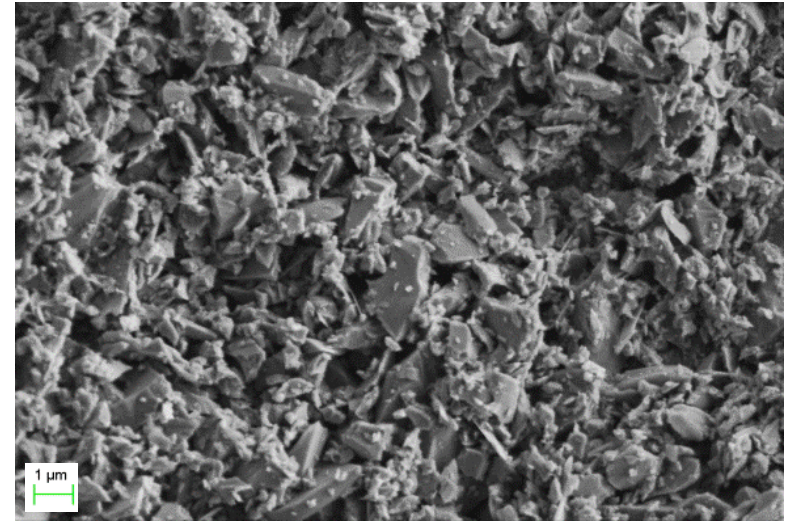
- SPS SiC samples using several different types of  $B_4C$  additives with varying size and morphology
  - Commercial  $B_4C$  powders from ESK, H.C. Starck
  - $B_4C$  powder made at Rutgers via rapid carbothermal reduction
- SPS SiC samples using different processing methods
  - Dry mixing in SpectroMill
  - Filter press from ball milled slurry
- Use ultrasound methods to determine elastic properties and predict microstructural features
  - Use both conventional ultrasound NDE techniques and Acoustic Spectroscopy
- Perform FESEM imaging to characterize microstructure
  - Compare NDE predictions with FESEM images
- Examine relationship between additive size/morphology and processing methods and SiC microstructure and acoustic properties



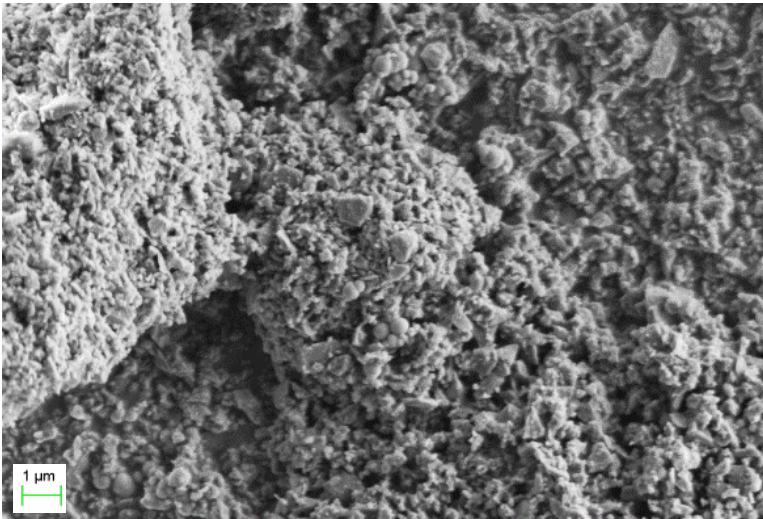
# Boron Carbide Additives



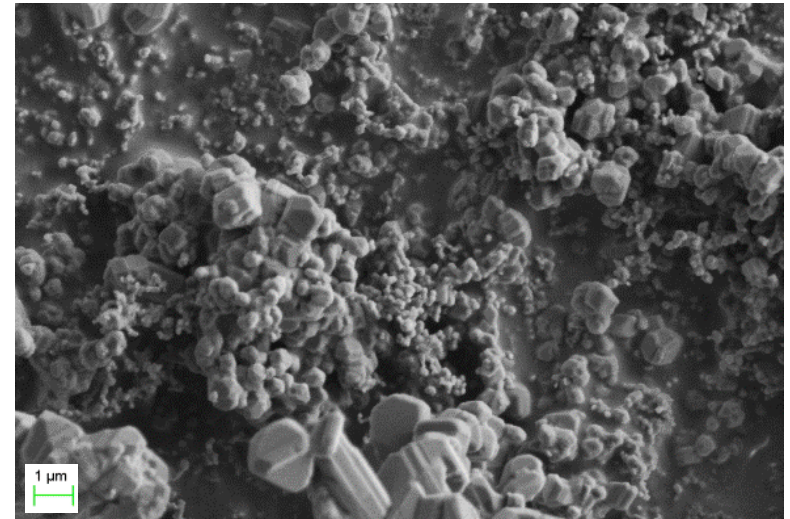
ESK Tetrabor 1250 mesh  
(d50: approx 6μm)



ESK Tetrabor 3000F  
(d50: approx 1μm)



H.C. Starck HD20  
(d50: 0.3 - 0.6μm)



Rutgers RCR SF5  
(d50: 0.59μm)



# SiC with Different Additive Size and Morphology

- Ball milled in ethanol 3 hours
- H.C. Starck UF-25 SiC
- 0.5% or 1.0% B<sub>4</sub>C
- 1.5% Fisher Lamp Black
- Different types of B<sub>4</sub>C additives
  - ESK Tetrabor 3000F
  - ESK Tetrabor 1250 mesh
  - H.C. Starck HD20
  - Rutgers RCR SF5

Sample	B <sub>4</sub> C added
1a	0.5% ESK Tetrabor 3000F
1b	1.0% ESK Tetrabor 3000F
2a	0.5% ESK Tetrabor 1250mesh
2b	1.0% ESK Tetrabor 1250mesh
3a	0.5% HCStarck HD20
3b	1.0% HCStarck HD20
4a	0.5% Rutgers SF5
4b	1.0% Rutgers SF5

- Sintered in Thermal Technologies SPS 10-4 unit
  - Argon atmosphere
  - 50MPa pressure

Ramp to 1400°C at 200°C/min



Hold at 1400°C for 1min



Ramp to 1850°C at 200°C/min



Hold at 1850°C for 5min



Ramp to 1950°C at 200°C/min



Hold at 1950°C for 13min



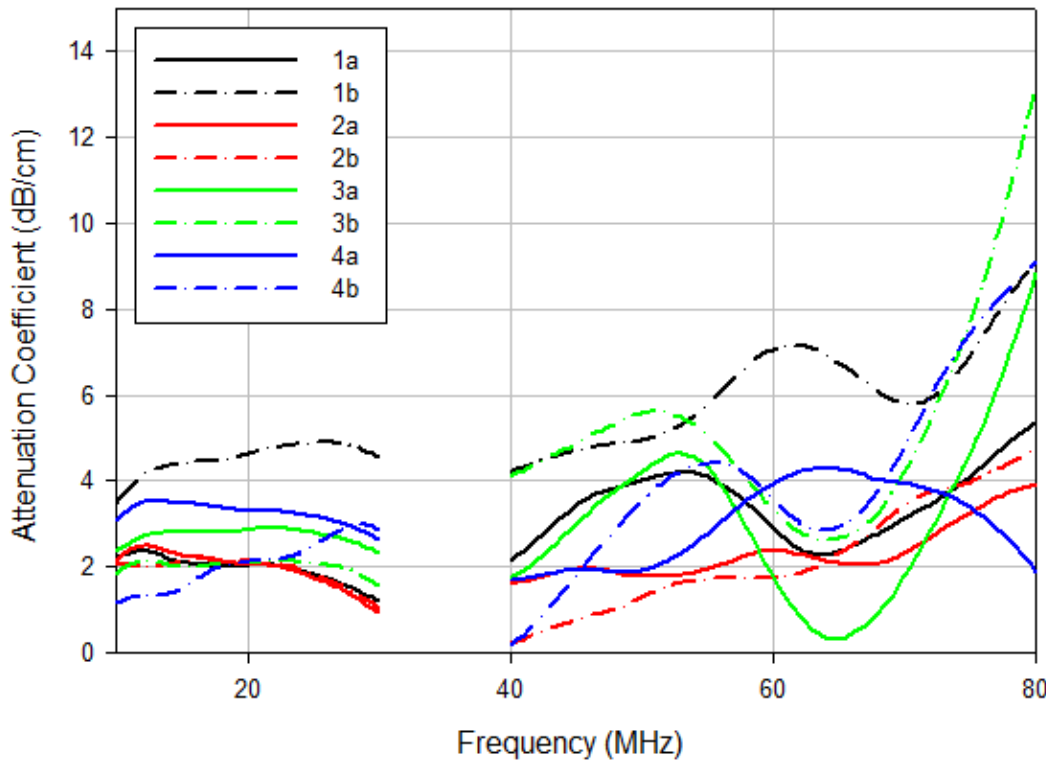
Off

Ultrasound NDE, mechanical sectioning and FESEM imaging for characterization



# Ultrasound Results

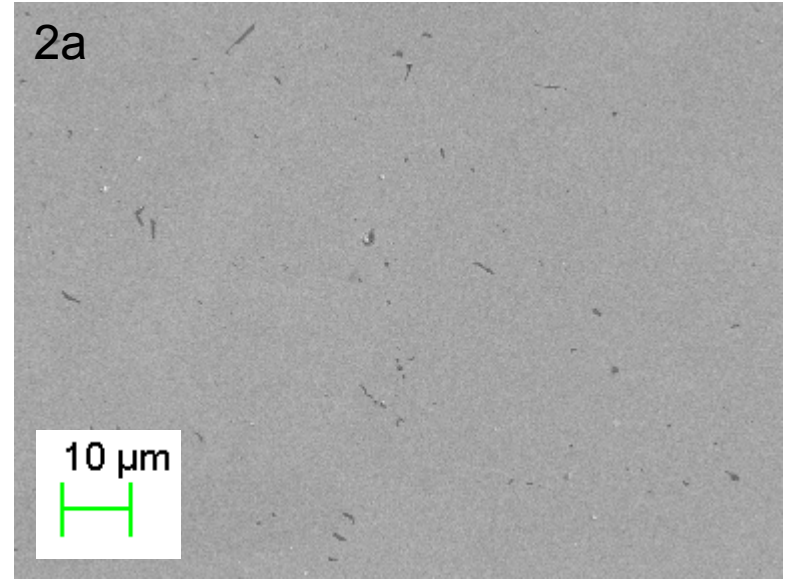
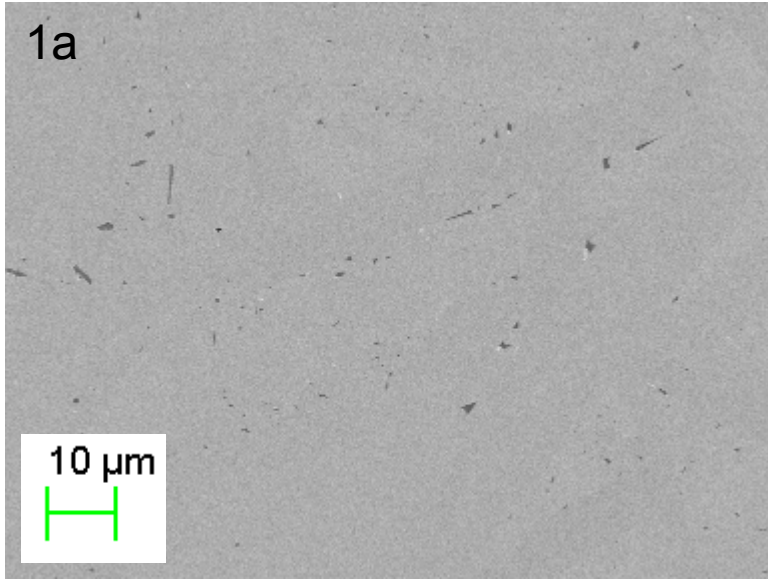
10-80MHz Attenuation Spectra



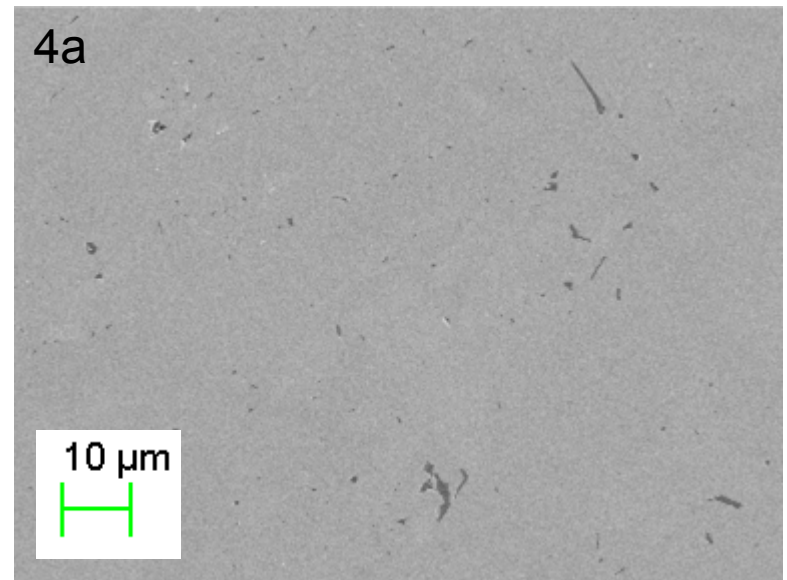
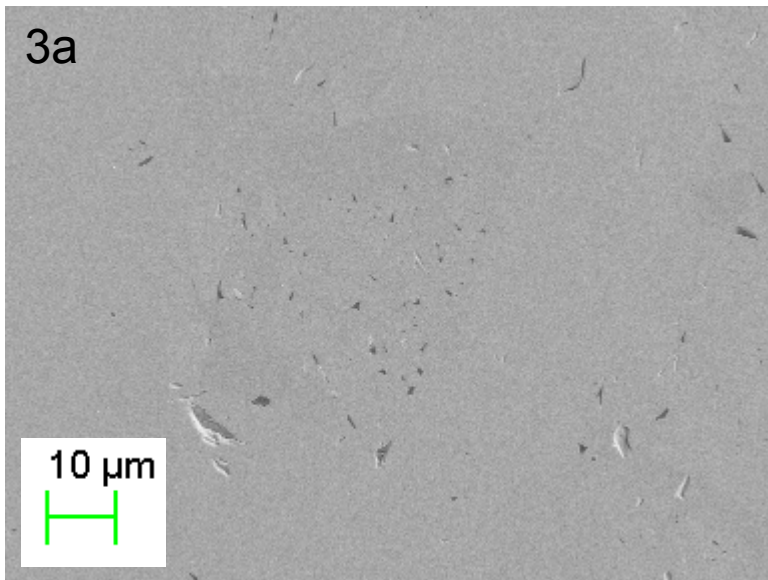
- No sharp peaks at lower frequencies
  - Broad inclusion size distribution
  - Inclusions too large/small
- Anomalous behavior at higher frequencies
  - Non-uniform grain size distribution
  - Surface effects
- Both absorption and scattering assume spherical particles – what if we don't have these?

Sample	cL (m/s)	cS (m/s)	Poisson	Density	E (GPa)	G (GPa)	K (GPa)
1a (0.5% ESK Tetrabor 3000F)	12293	7496	0.204	3.20	433	180	244
1b (1.0% ESK Tetrabor 3000F)	12211	7484	0.199	3.19	429	179	237
2a (0.5% ESK Tetrabor 1250 mesh)	12324	7475	0.209	3.20	432	179	248
2b (1.0% ESK Tetrabor 1250 mesh)	11974	7376	0.194	3.19	415	174	226
3a (0.5% HCStarck HD20)	12184	7590	0.183	3.20	436	184	229
3b (1.0% HCStarck HD20)	12384	7471	0.214	3.20	434	179	253
4a (0.5% Rutgers SF5)	12295	7478	0.207	3.20	432	179	246
4b (1.0% Rutgers SF5)	12270	7443	0.209	3.20	429	177	245

# 0.5% B<sub>4</sub>C Additive



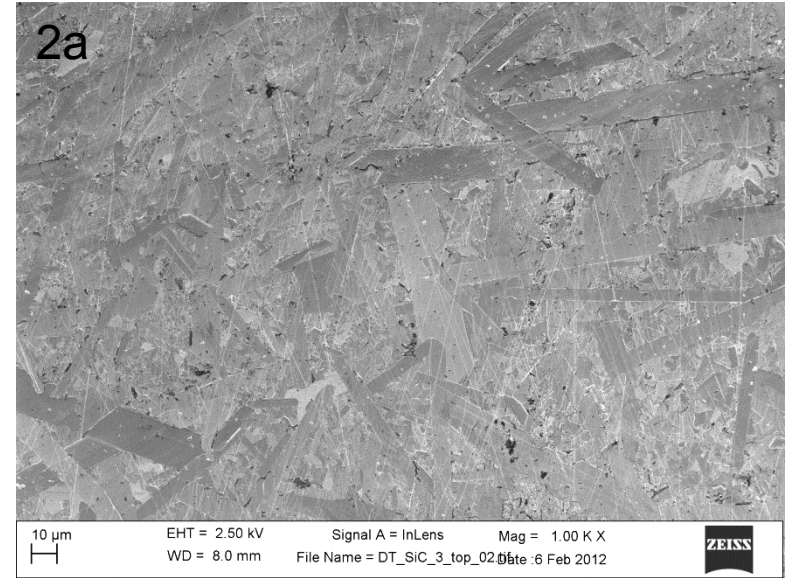
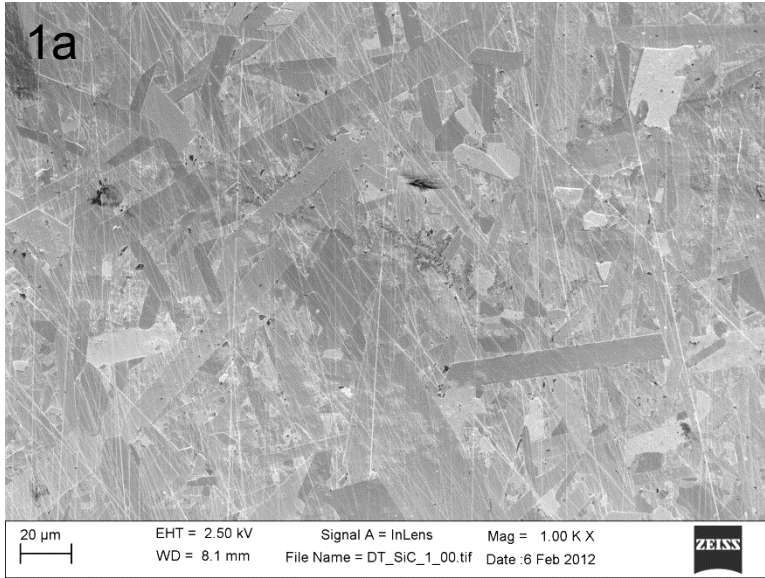
Size of ESK fibers are consistent, even with ESK fiber additive



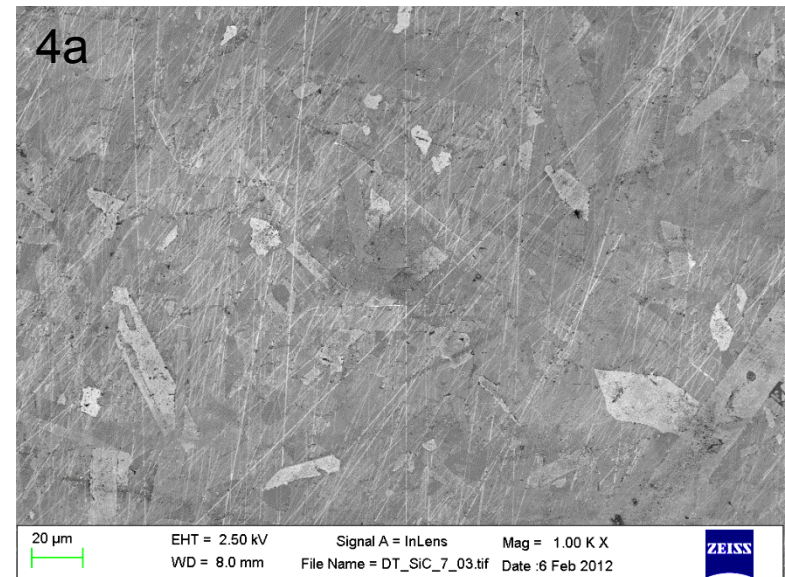
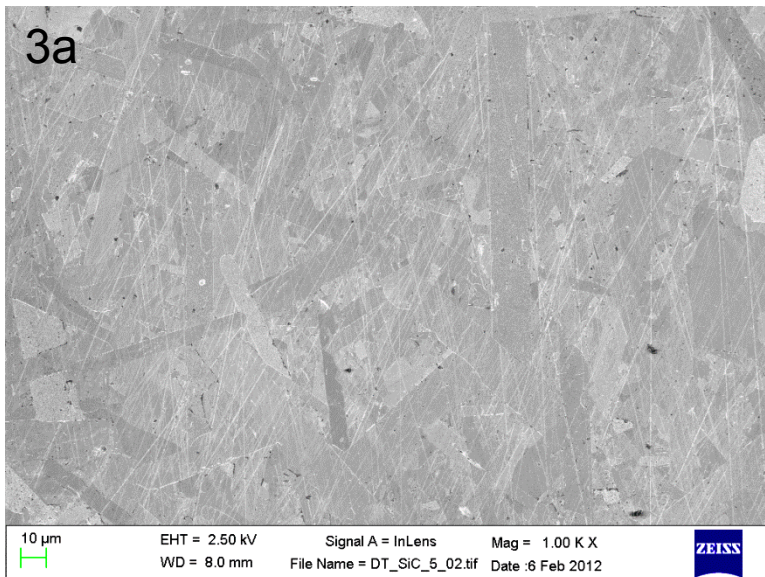
0.5% HAC starts HD dense with little if any visible porosity



# 0.5% B<sub>4</sub>C Additive



All samples show large, elongated grains

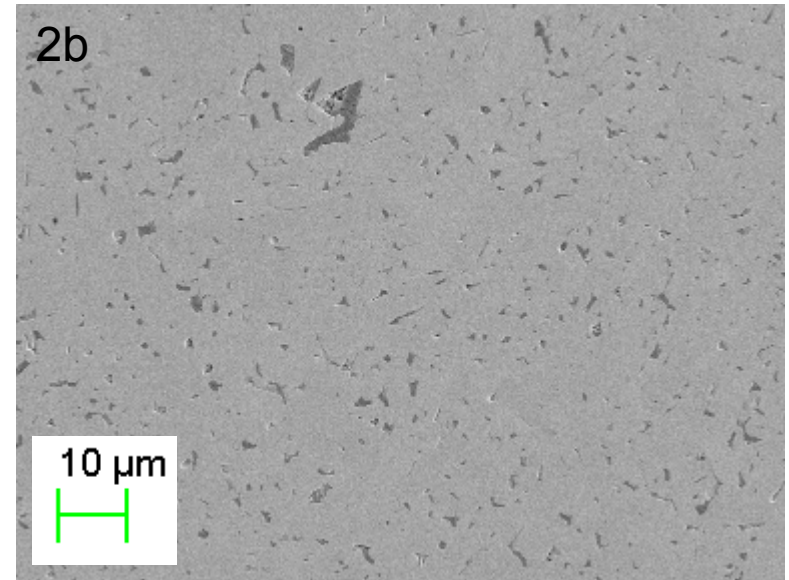
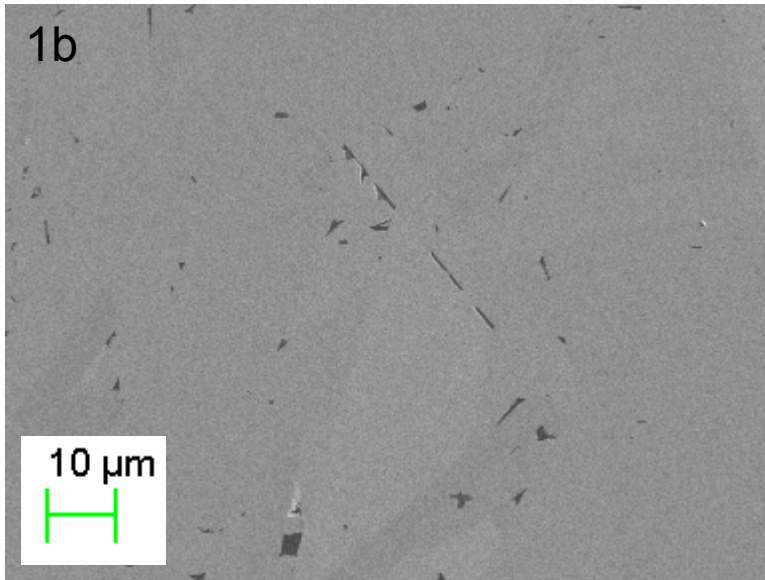


Sample 2a shows smaller average grain size, fewer very large grains

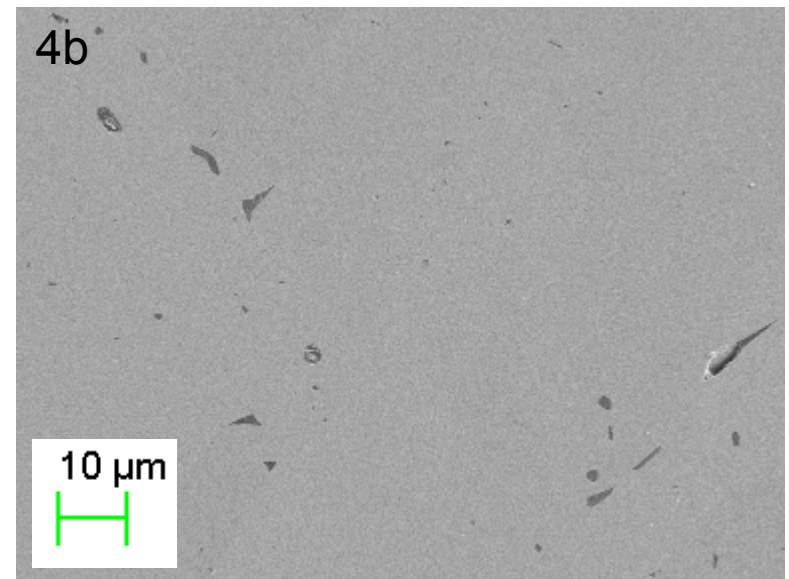
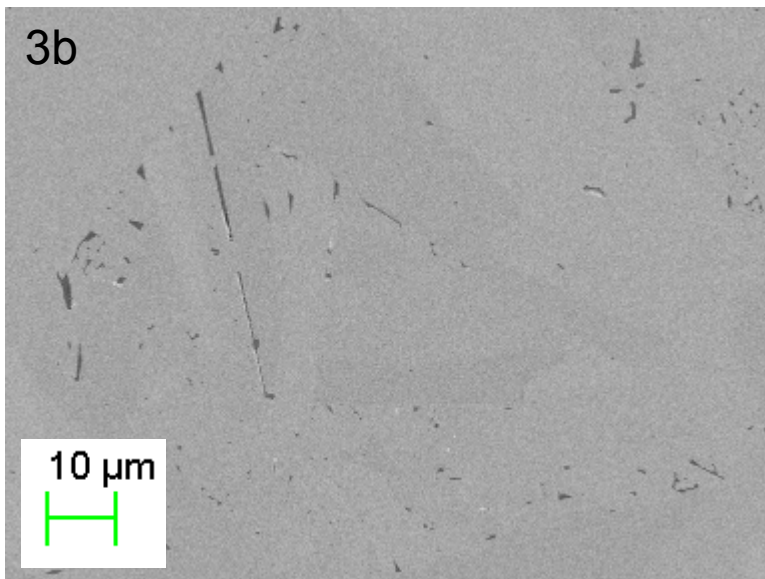




# 1.0% B<sub>4</sub>C Additive



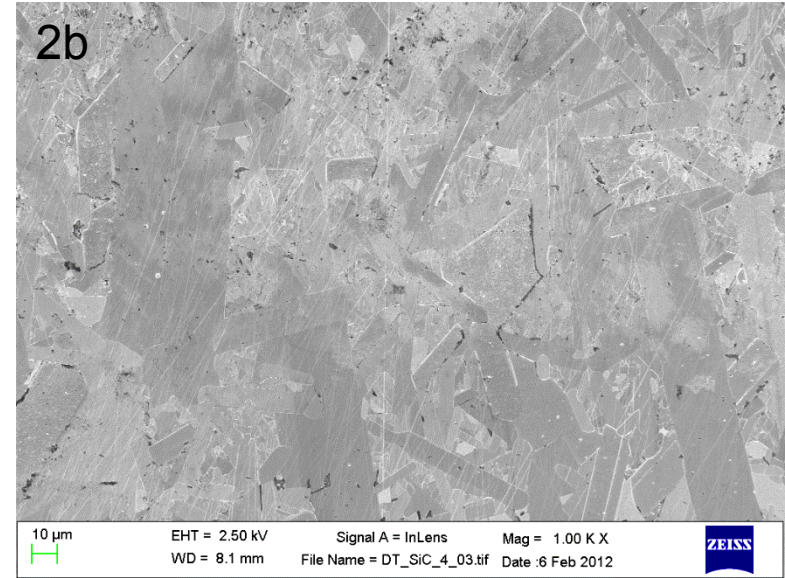
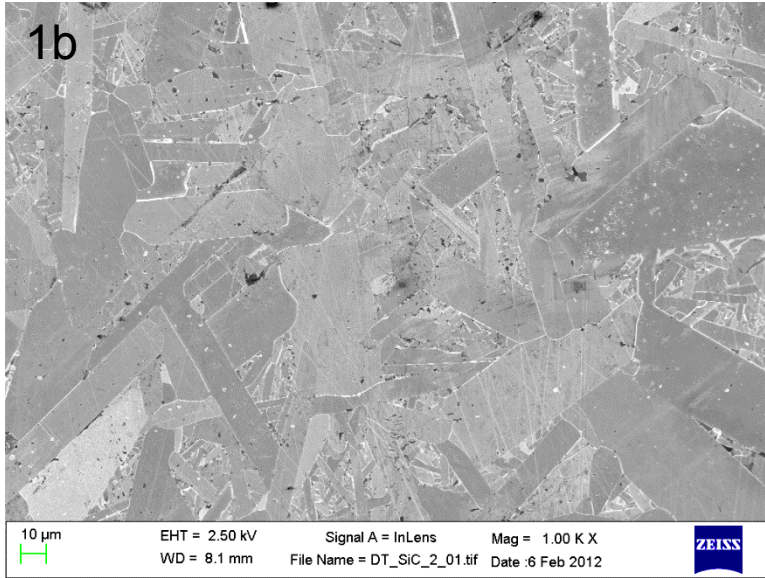
1.0% ESKM for additive 3000 → more inclusions, larger inclusions  
1.0% ESKM for additive 1250 mesh



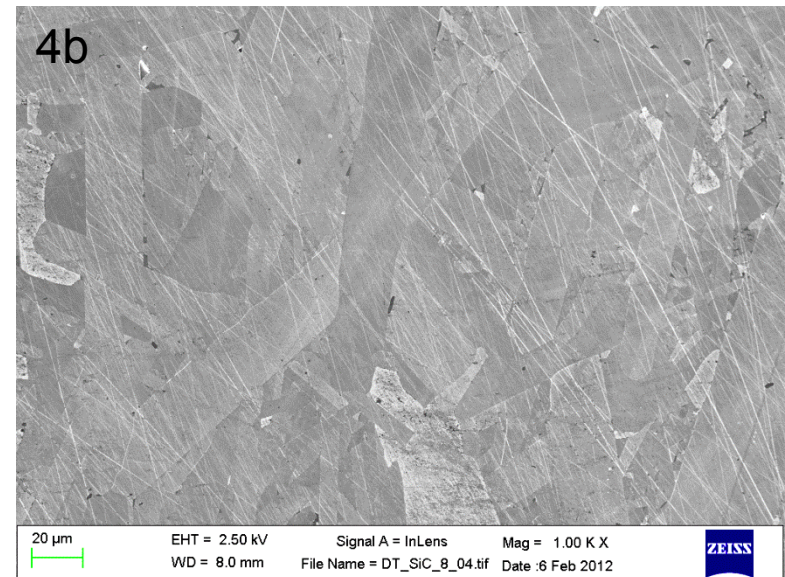
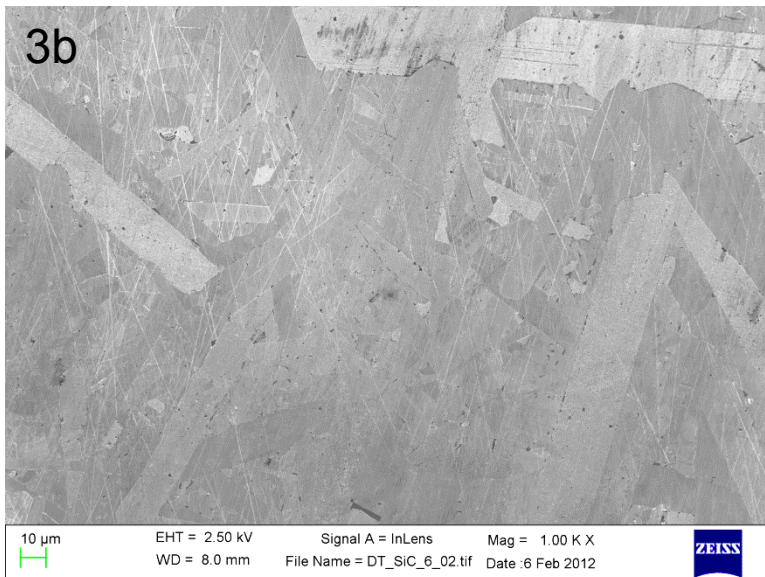
1.0% HAC - Starts HD dense with little if any visible porosity  
1.0% Potash SF5



# 1.0% B<sub>4</sub>C Additive



Samples still show elongated grains



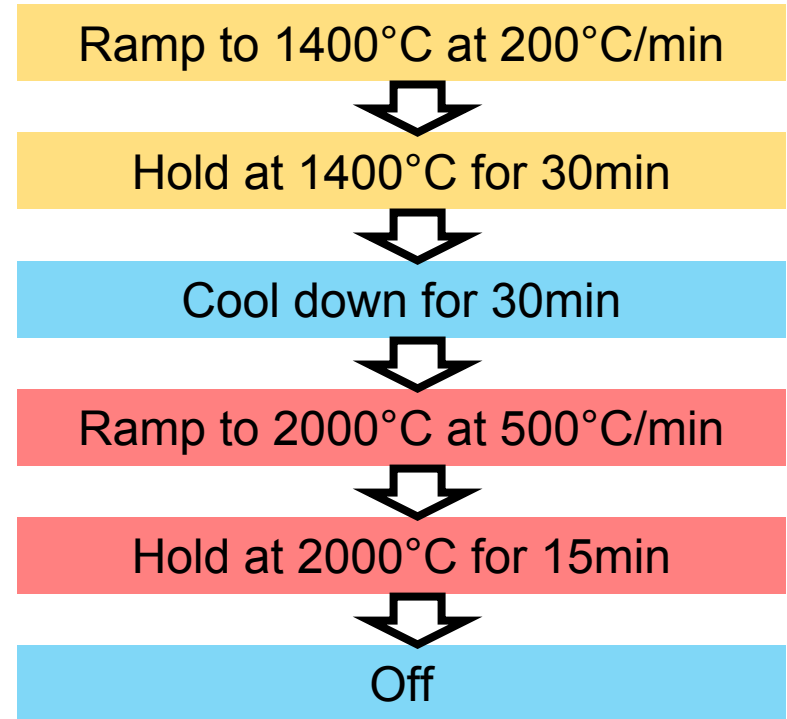
Again, larger B<sub>4</sub>C additive seems to reduce average grain size



# SiC Made with Different Processing Methods

- Mark I - Baseline sample
  - Dry mixed in SpectroMill
  - H.C. Starck UF-25 SiC
  - 0.5% ESK Tetrabor 3000F B<sub>4</sub>C
  - 1.0% Fisher Lamp Black C
  
- Mark II - Filter-pressed samples
  - Ball milled in ethanol 24 hours
  - Filter pressed at 15psi
  - H.C. Starck UF-25 SiC
  - 0.5% Rutgers SF5 B<sub>4</sub>C
  - 1.5% Fisher Lamp Black C

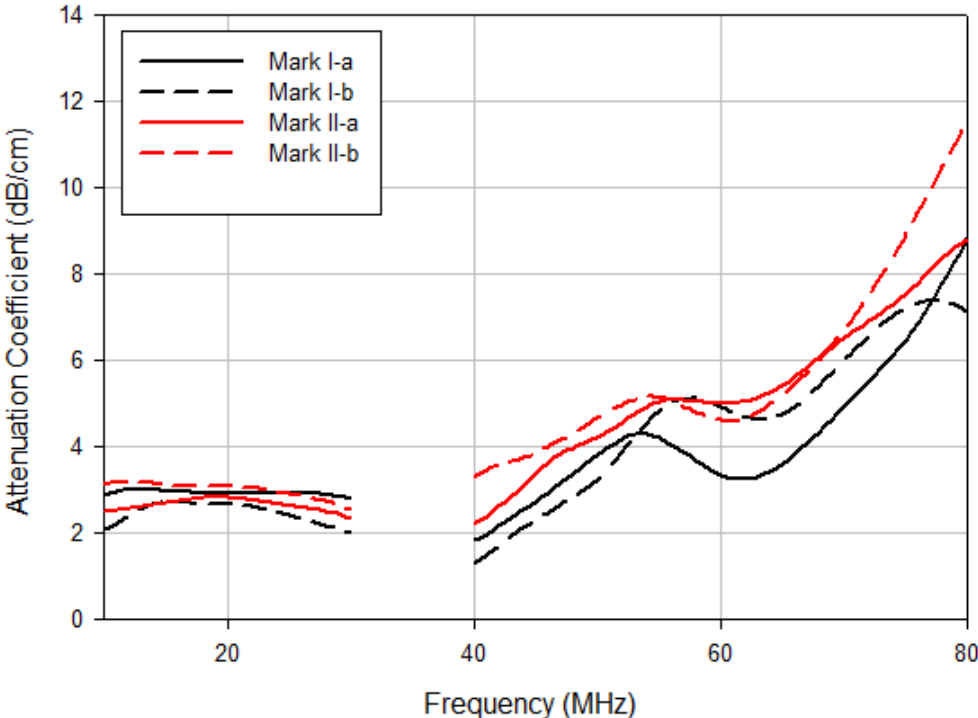
- Sintered in Thermal Technologies SPS 10-4 unit
  - Argon atmosphere
  - 50MPa pressure



# Ultrasound Evaluation

Sample	cL (m/s)	cS (m/s)	Poisson	Density (g/cc)	E (GPa)	G (GPa)	K (GPa)
Mark I-a	12196	7589	0.184	3.20	437	185	231
Mark I-b	12072	7486	0.188	3.20	426	179	227
Mark I-c	12054	7459	0.190	3.21	424	178	228
<b>Average</b>	<b>12107</b>	<b>7511</b>	<b>0.187</b>	<b>3.20</b>	<b>429</b>	<b>181</b>	<b>229</b>
Mark II-a	12258	7451	0.207	3.21	430	178	245
Mark II-b	12213	7455	0.203	3.21	429	178	241
Mark II-c	12209	7394	0.210	3.21	425	176	244
<b>Average</b>	<b>12227</b>	<b>7433</b>	<b>0.207</b>	<b>3.21</b>	<b>428</b>	<b>177</b>	<b>243</b>

10-80MHz Attenuation Coefficient Spectra

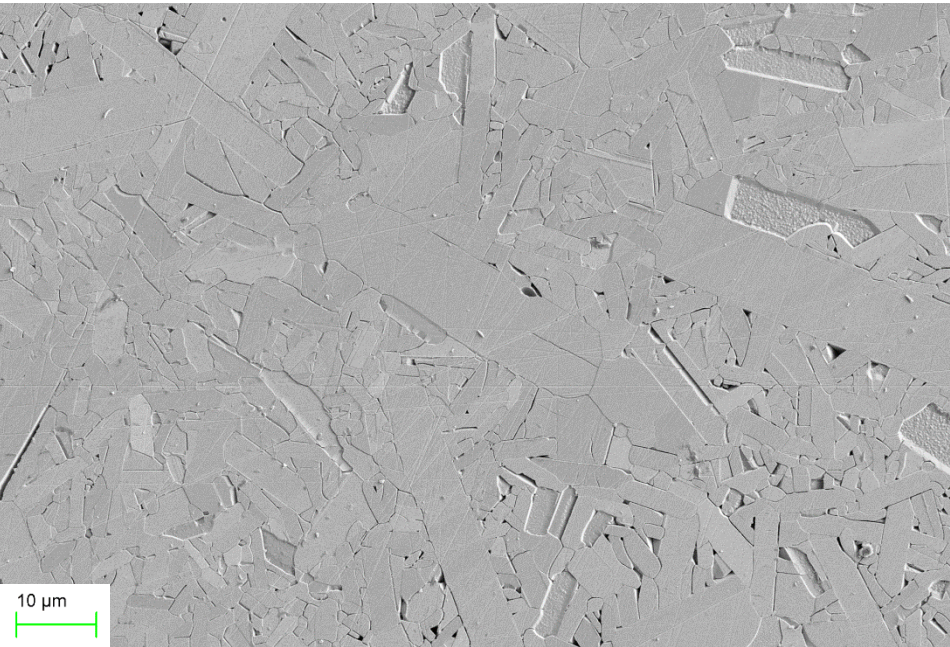


- Sample elastic properties comparable to commercial materials
- Attenuation behavior similar at low frequencies
- Behavior differs at higher frequencies, due to grain size and shape effects



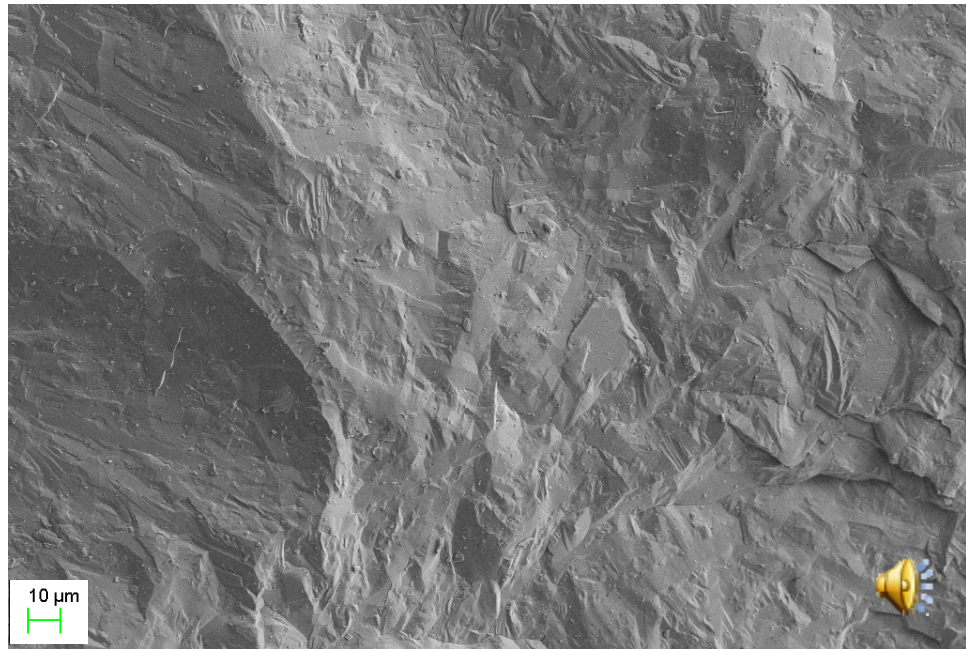
# Mark I SEM

Mark I etched



- Some elongated, high aspect ratio grains present
- Appears to have a bimodal grain size distribution
- Mainly smaller grains with some larger ones

Mark I fracture surface

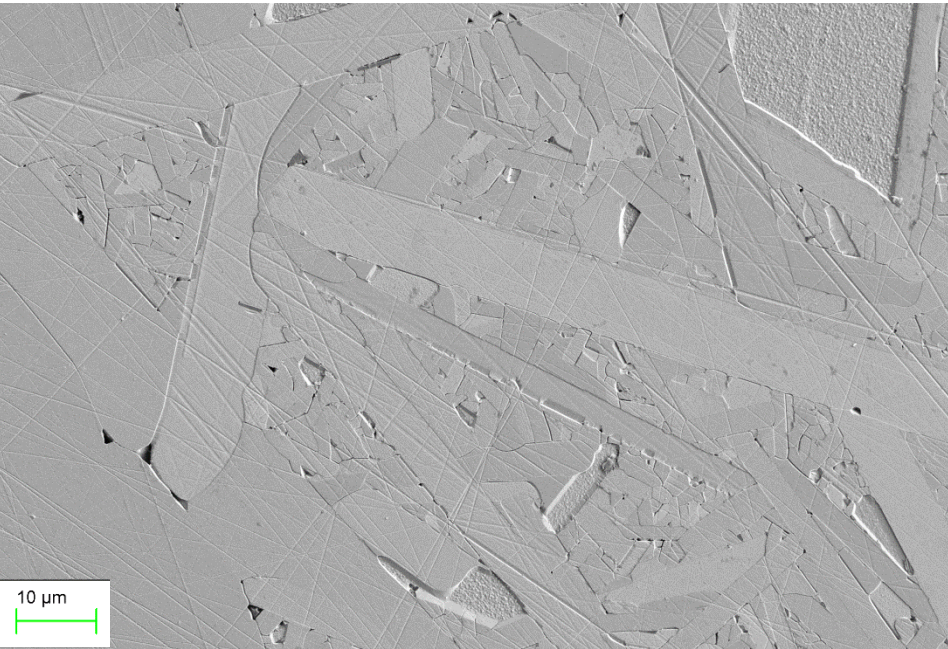


- Fragment from dynamic testing
- Predominantly transgranular fracture



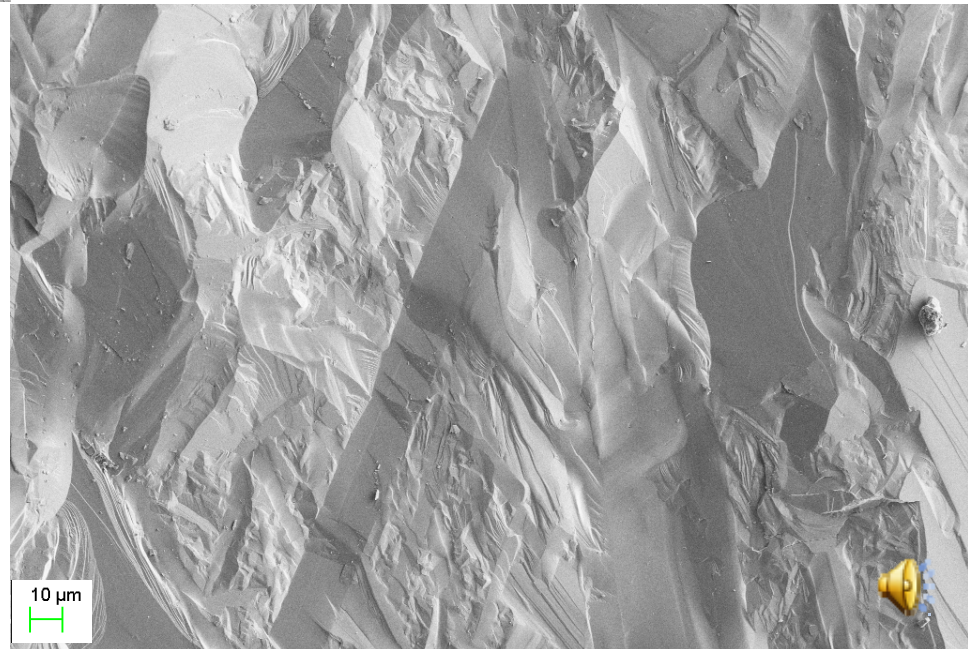
# Mark II SEM

Mark II etched



- Many elongated, high aspect ratio grains present
- Appears to have a bimodal grain size distribution
- Many large grains with smaller grains between them

Mark II fracture surface



- Predominantly transgranular fracture
- Clean fracture surfaces – no C or B<sub>4</sub>C evident

# Summary

- Ultrasonic testing was performed to measure elastic properties, predict microstructural characteristics of SPS SiC samples
  - Anomalous behavior precluded quantitative estimates of secondary phase inclusion and SiC grain size
- FESEM imaging showed predominantly large, high aspect ratio grains
- Different additive samples
  - Smaller B<sub>4</sub>C additives show much cleaner microstructures, even with higher additive content
  - Larger additive size appears to decrease SiC grain size
  - Additive morphology doesn't appear to have much of an effect
- Different processing method samples
  - Samples show similar elastic properties and acoustic behavior, but show very different microstructures
- Irregular grain shapes and wide grain size distribution must be corrected before definitive conclusions can be made



# Future Work

- Fabricate SiC samples with  $B_4C$  and C additions via SPS
  - Use different sintering cycles to produce more equiaxed grains
    - Prepare samples using different processing methods
    - Use different size/purity  $B_4C$ , C starting materials
    - Generate standard samples with varying grain sizes, additives
- Ultrasound characterization of standard samples to determine:
  - Scattering prefactors
    - Grain size measurements
  - Absorption mechanisms
    - Secondary phase size distributions, concentrations
- Expand transducer library to fill frequency gap between 30 – 40 MHz, expand capabilities to lower, higher frequencies

